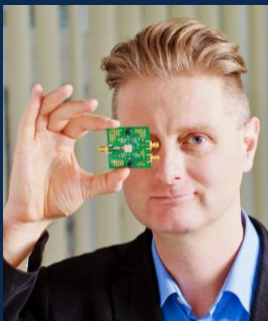


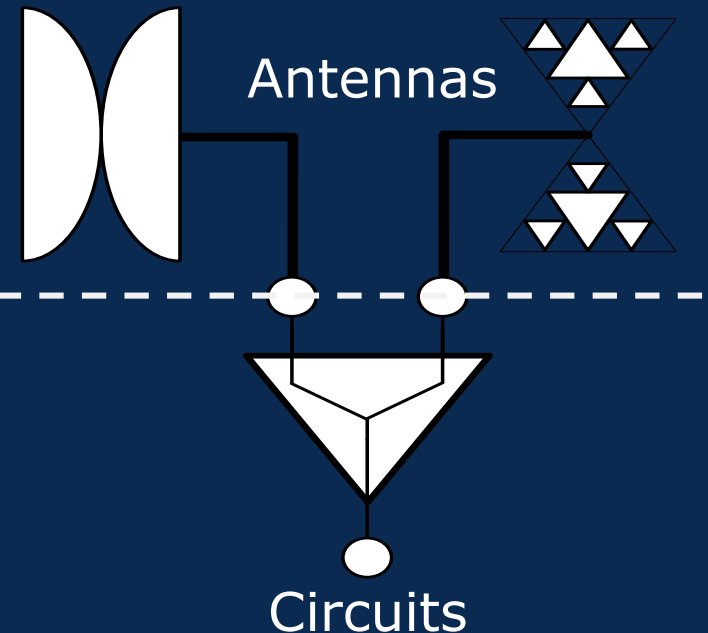
On-Chip Integrated Distributed Amplifier and Antenna Systems in SiGe BiCMOS for Ultra-Large-Bandwidth Transmitters



Prof. Dirk Plettemeier
TU Dresden
Chair for RF Engineering



Prof. Frank Ellinger
TU Dresden
Chair for Circuit Design &
Network Theory

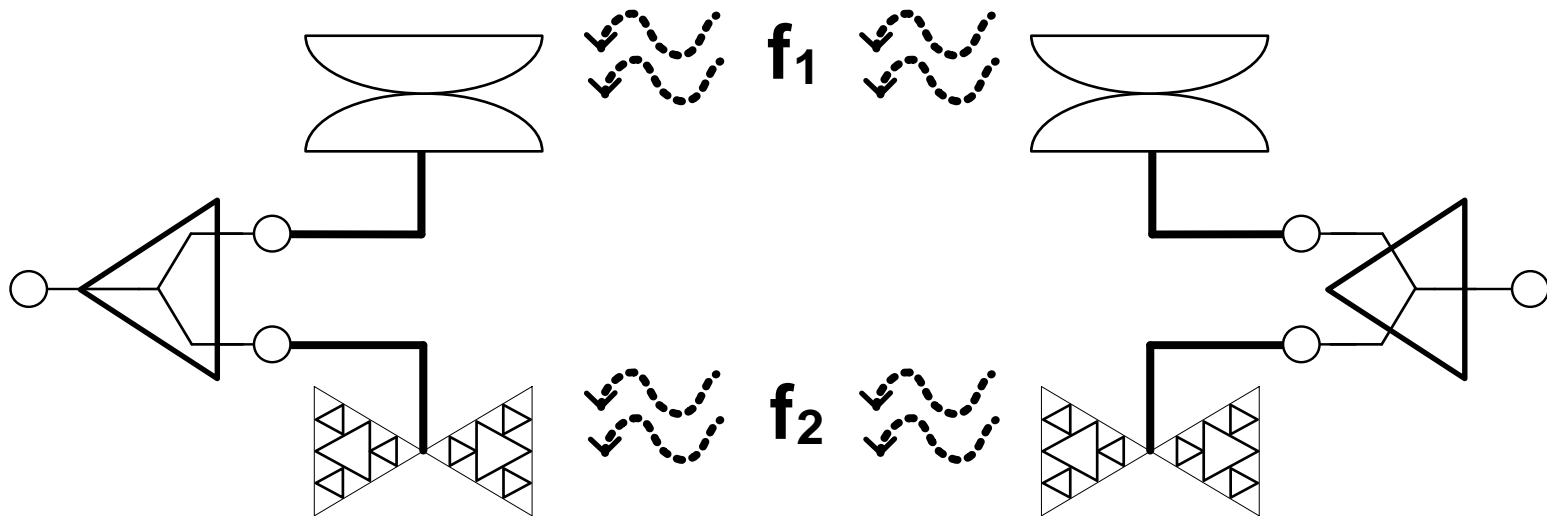


Major Goal

Integrated Antenna & Amplifier

Transceiver Frontend in SiGe

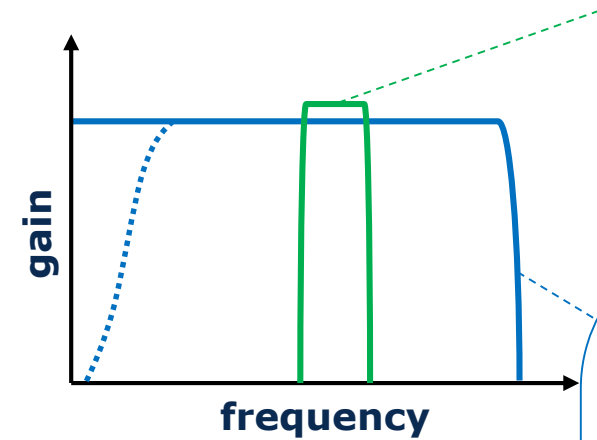
with 100 GHz BW to enable 100 Gb/s & beyond



Compared to SoA: **BW** improved by factor **5**

Traveling Wave Impedance Matching

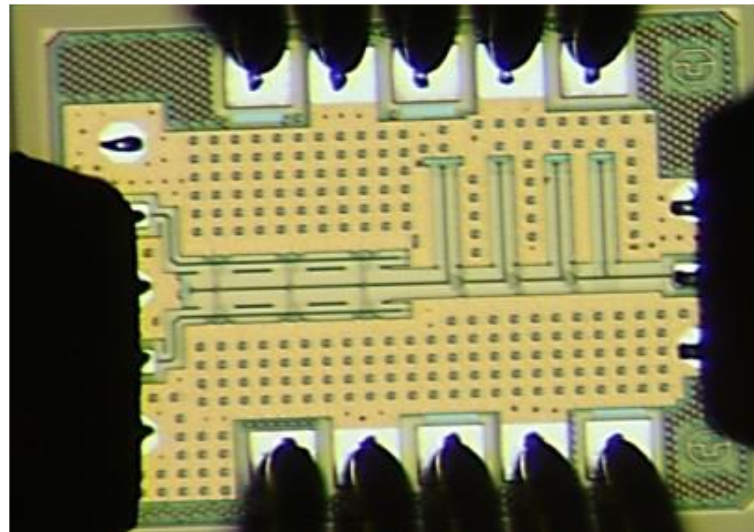
Approach to Achieve Maximum Bandwidth



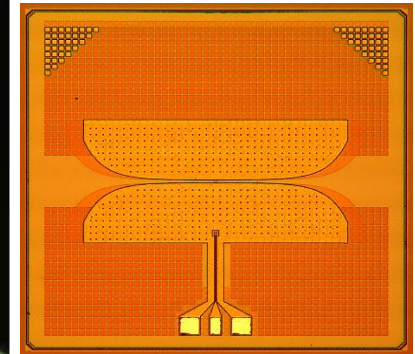
Conventional approach

Resonate capacitances with inductors

⇒ Low bandwidth



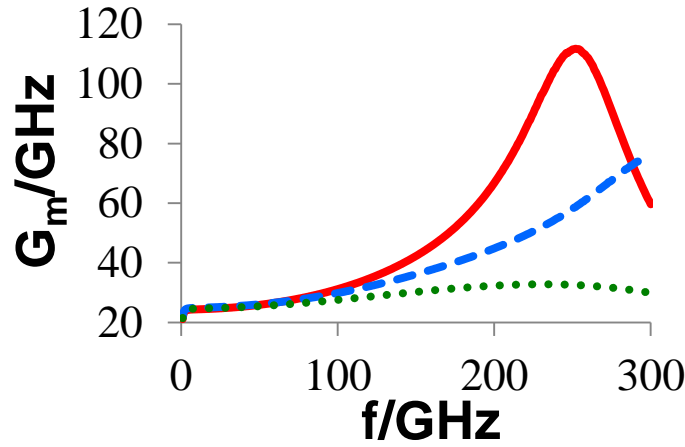
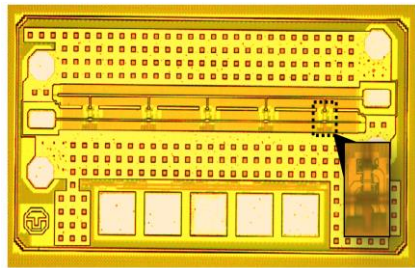
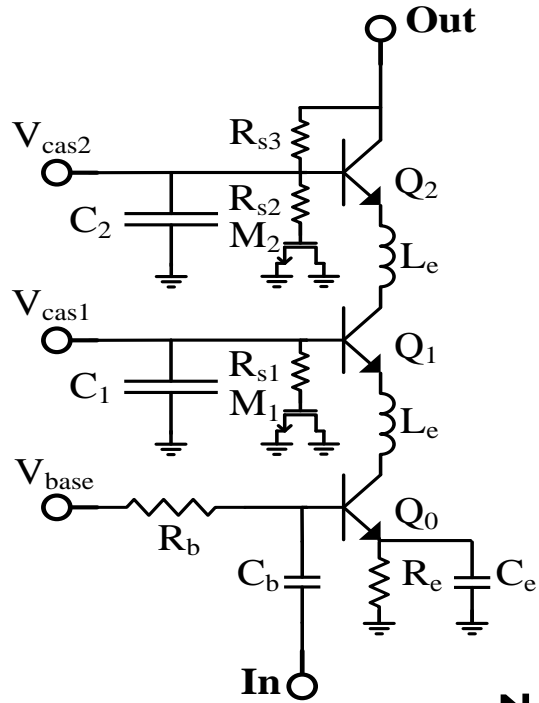
P. Testa, „220 GHz Wideband Distributed Active Power Combiner“



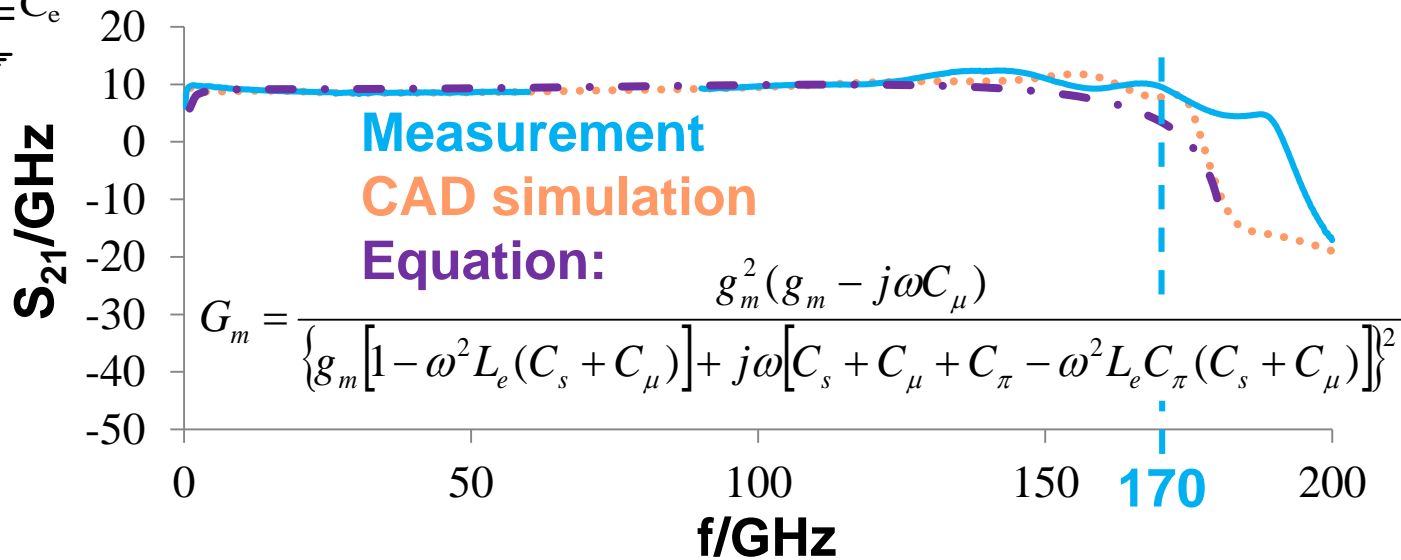
R. Hahnel, „Integrated stacked Vivaldi-shaped on-chip antenna for 180 GHz“

Amplifier concepts

Novel Triple Cascode Amplifier Cells for DC - 170 GHz TWA

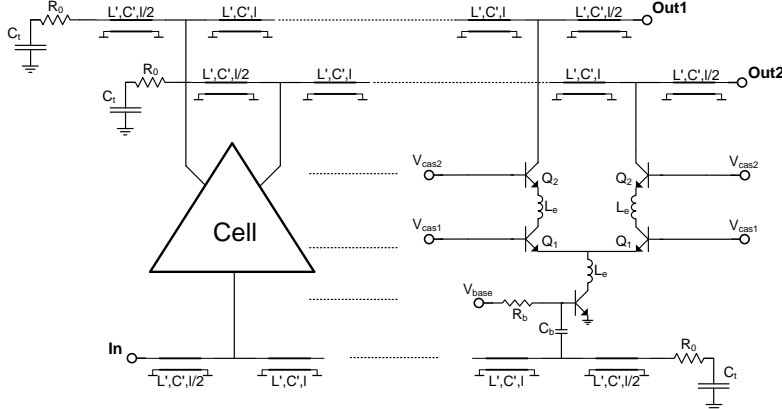
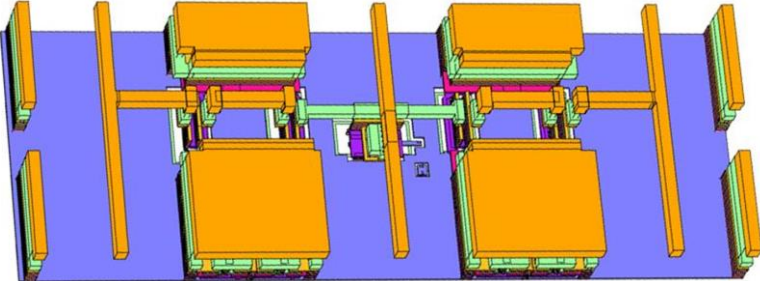
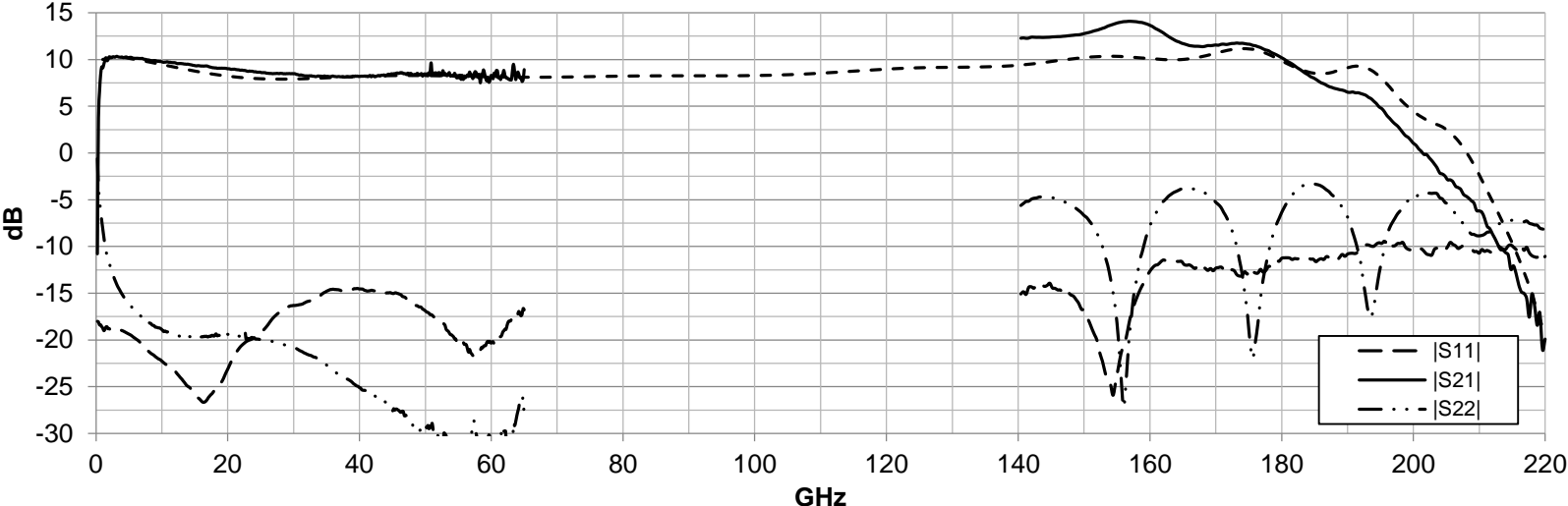


Novel Triple Cascode + L_e
 Cascode + L_e
 Conventional Cascode

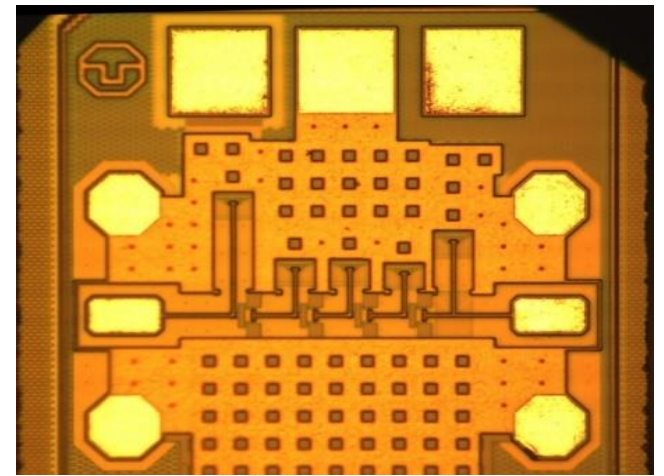
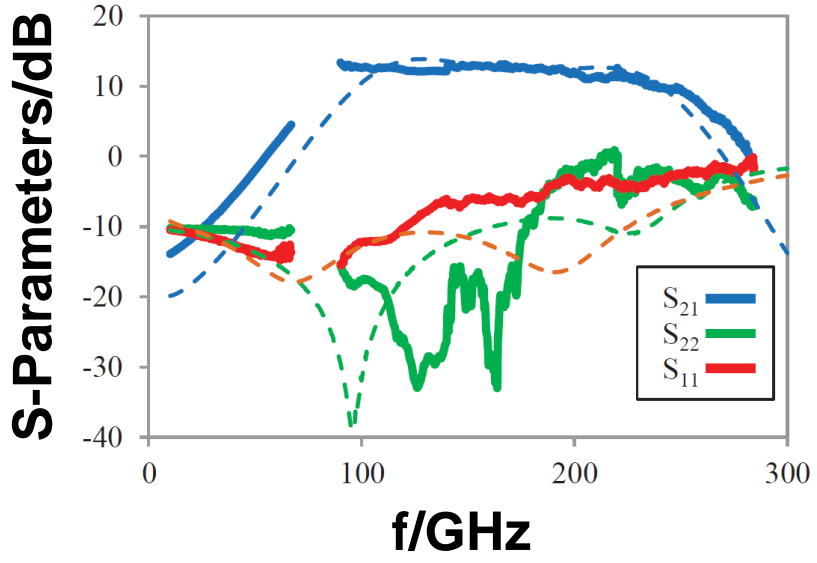
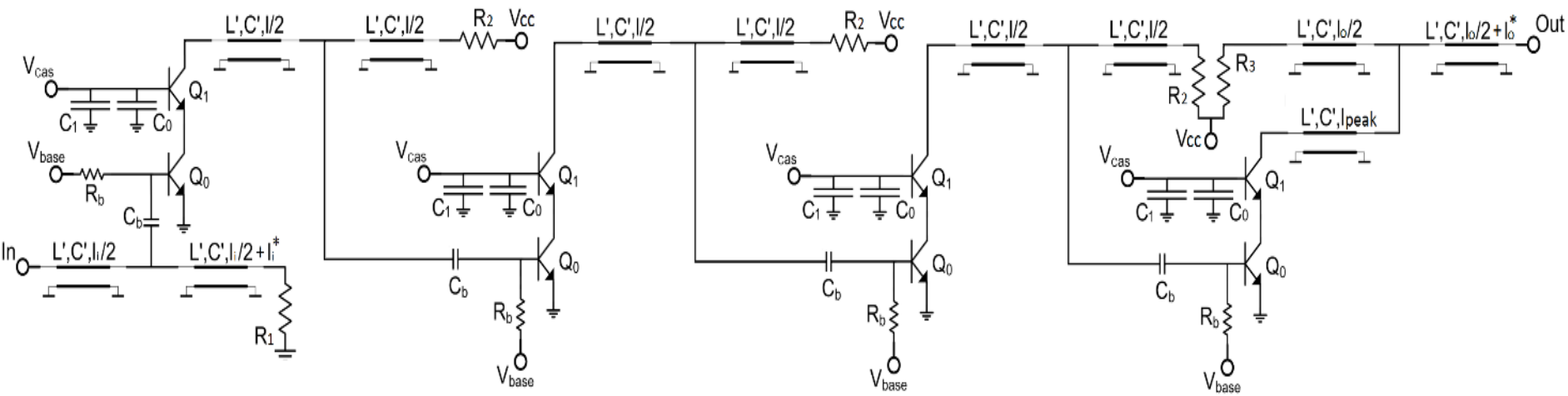


Novel triple cascode

Triple cascode to boost Gm and compensate the input line losses: 4 times faster than SOA



Cascaded Single-Stage TWA at 60 - 250 GHz in BiCMOS

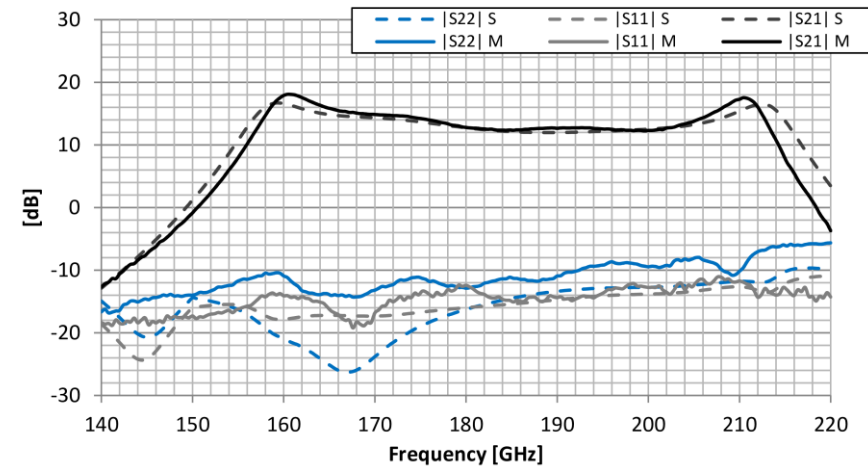
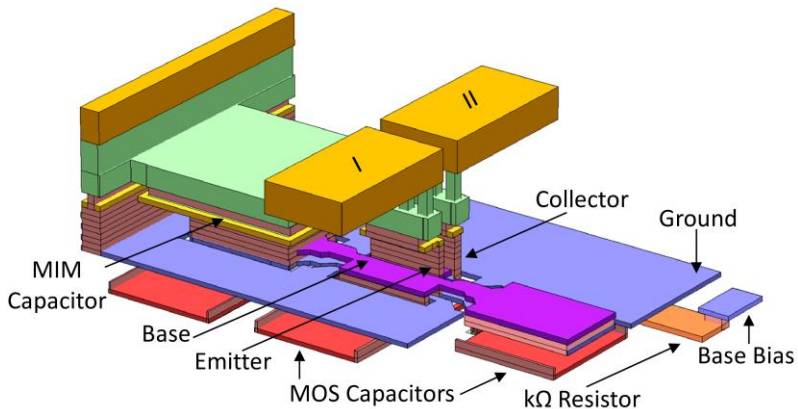
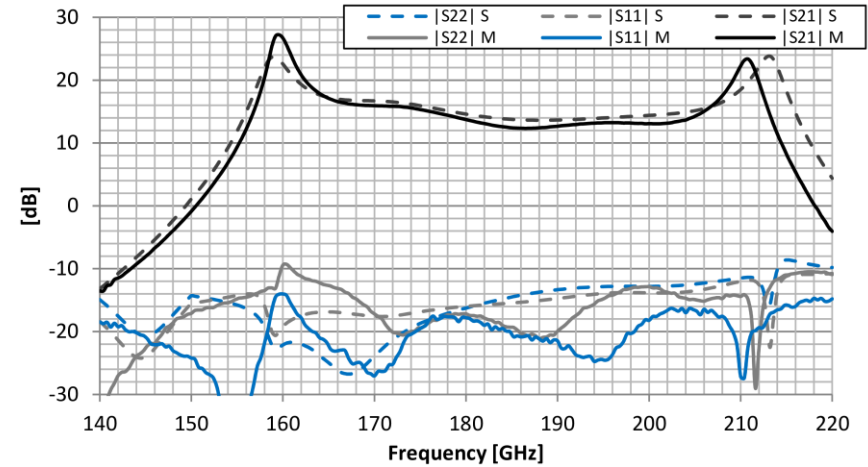
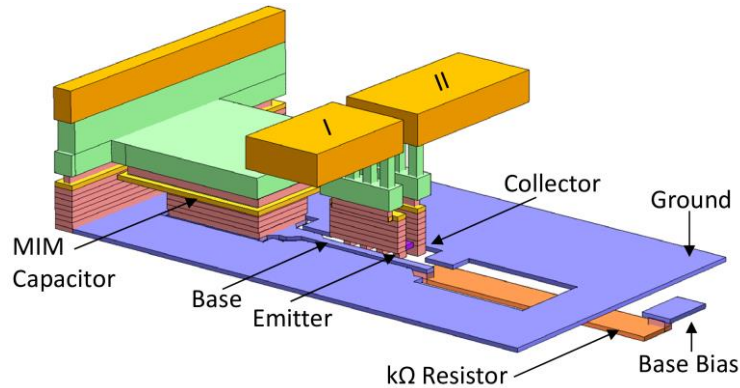


Comparison with State of the Art Broadband Amplifiers in Silicon

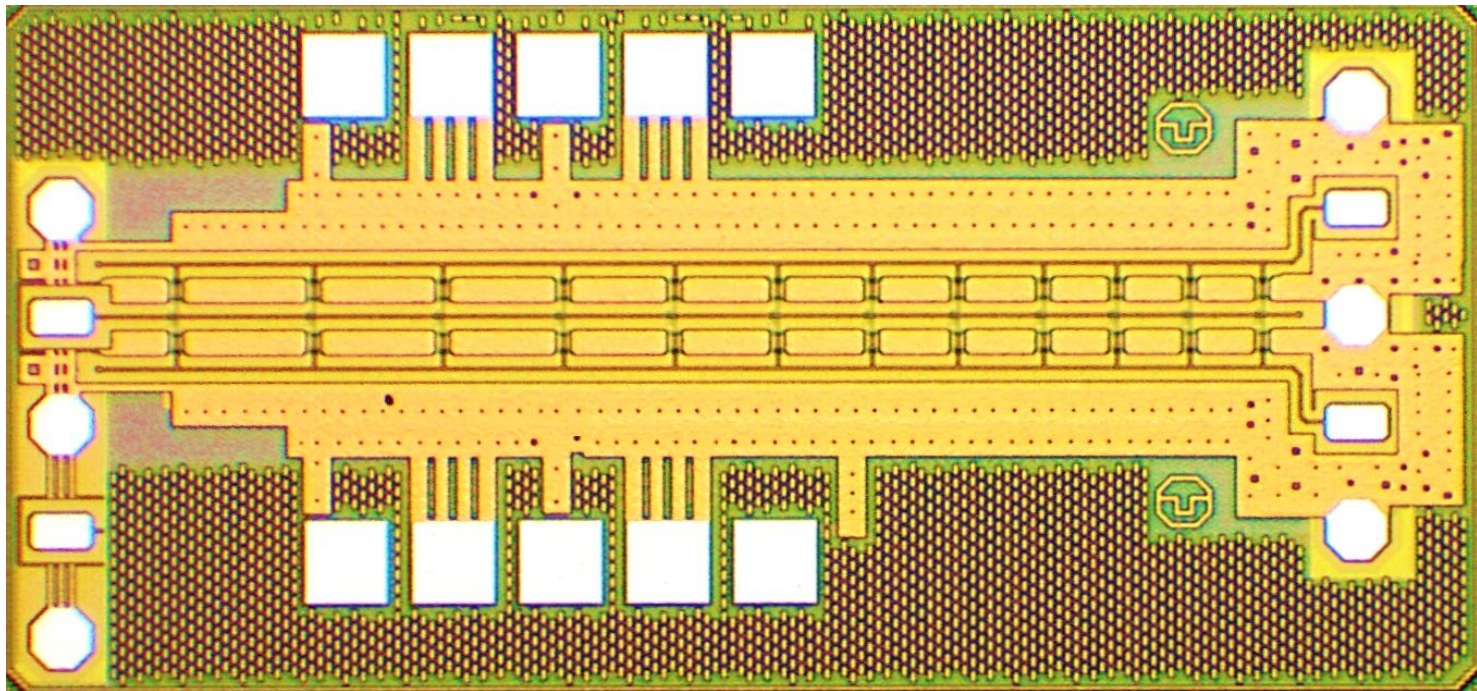
| FoM | 3 dB BW/ GHz | Gain/ dB | GBP/ GHz | Area/ mm ² | P _{DC} / mW | Tech | Ref. |
|-------------|-----------------|-------------|-------------|--------------------------|-------------------------|-----------------|--------------------|
| 3.6 | 0-70 | 13 | 312 | 1.7 | 120 | 90 nm CMOS | Chen EuMIC13 |
| 9.3 | 15-110 | 24 | 1500 | 0.7 | 247 | 0.13 μm SiGe | Niknejad RFIC12 |
| 13.8 | 0-170 | 10 | 537 | 0.4 | 108 | 0.13 μm SiGe | DAAB |
| 46 | 60-250 | 13 | 759 | 0.2 | 74 | | |

$$\rightarrow 5 \times \text{FoM} = \text{Gain} \times \text{BW} / (\text{Area} \times P_{\text{dc}})$$

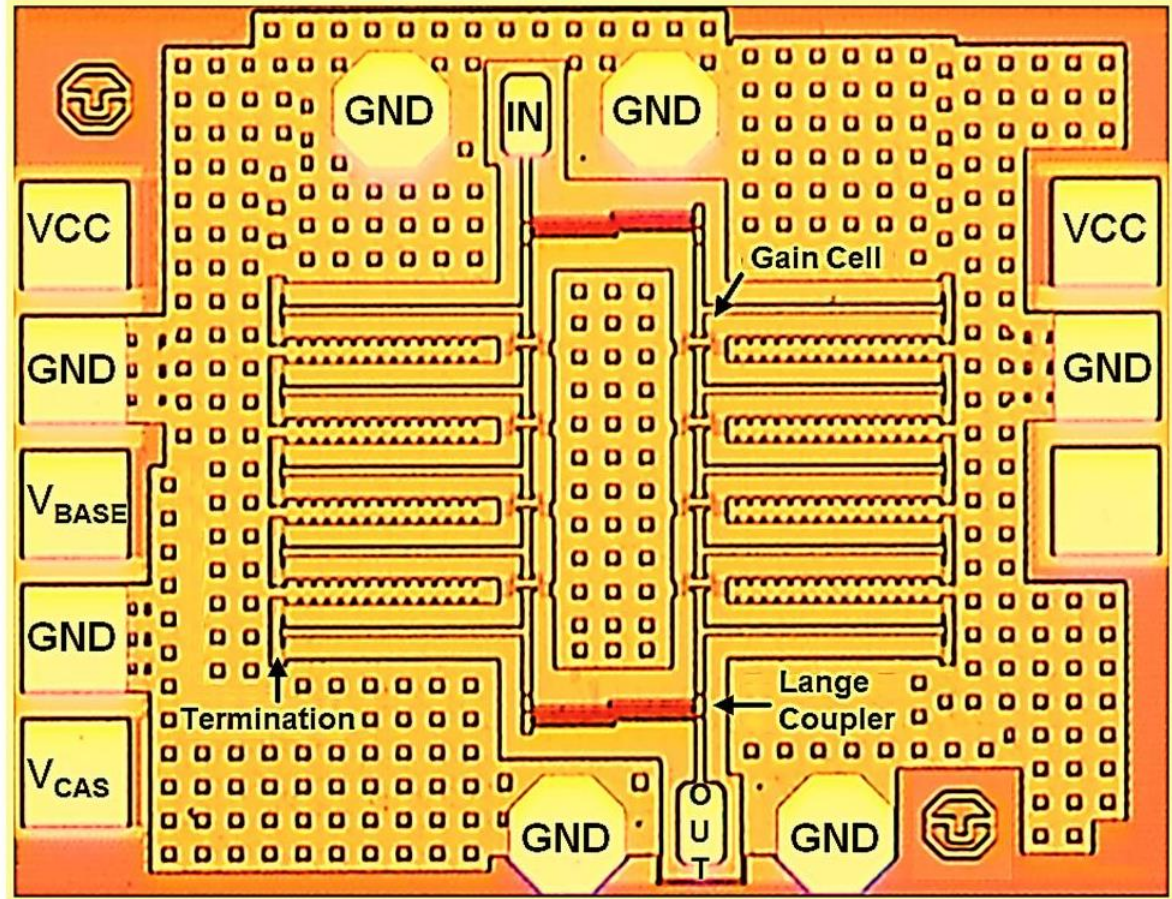
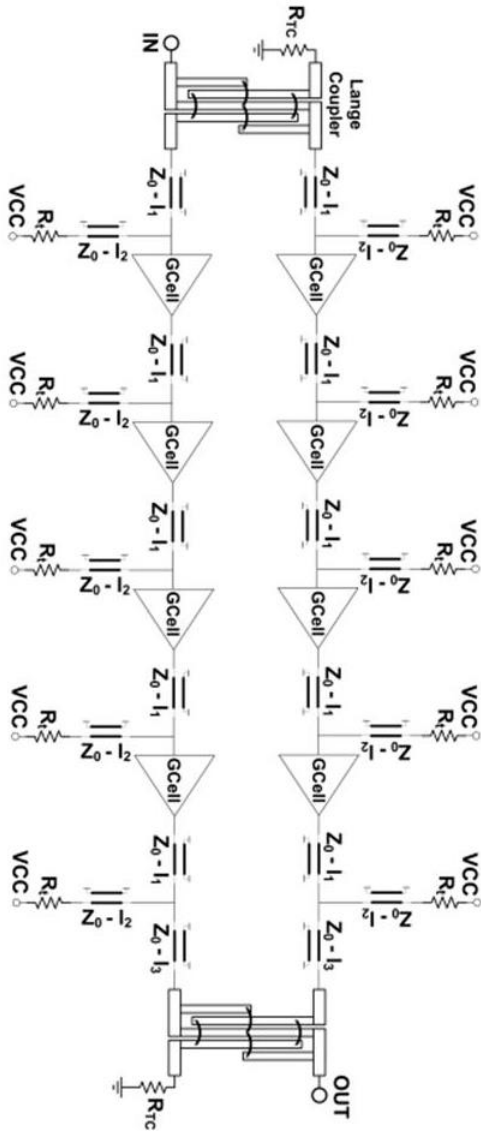
Layout for mmWave Common-Base Amplifiers



Distributed Power Divider



Balanced CSSDA

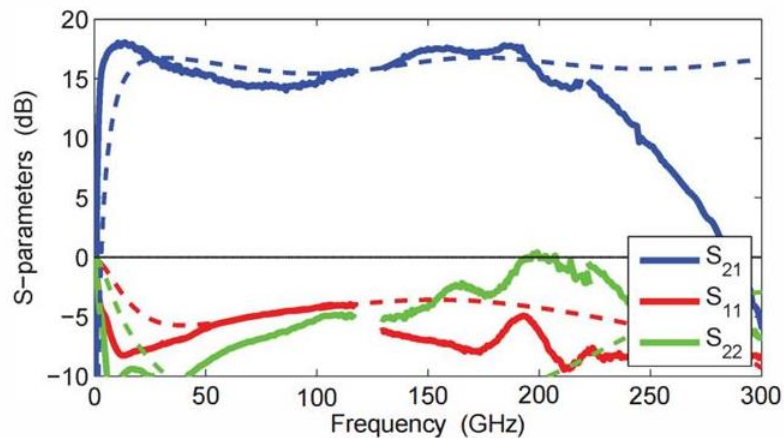


Never Tested Before

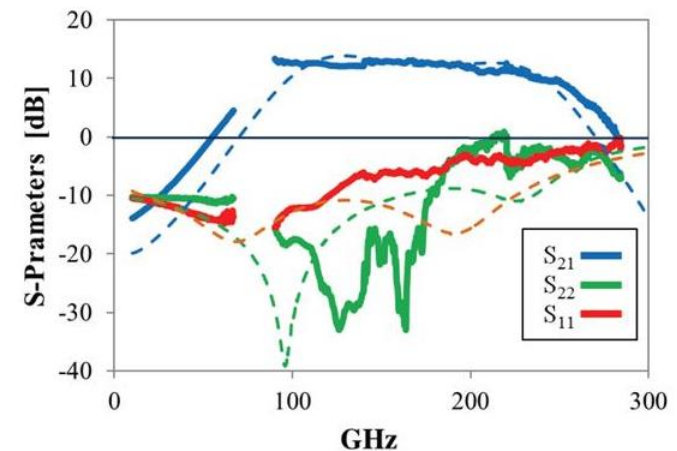
TABLE I COMPARISON OF PUBLISHED CSSDA

| | This work | [3] | [4] | [5] | [6] | [7] |
|-------------------------|-----------|------|------|------|------|------|
| Gain [dB] | 16 | 16 | 13 | 13 | 15 | 16 |
| Area [mm ²] | 0.38 | 0.54 | 0.22 | 0.72 | 0.31 | 1.36 |
| f_{UP} [GHz] | 220 | 235 | 250 | 70 | 80 | 65 |
| BW [GHz] | 180 | 235 | 170 | 70 | 80 | 40 |
| f_{max} [GHz] | 370 | 650 | 450 | 160 | n/a | n/a |
| Pout* [dBm] | 4 | n/a | -6 | 3 | n/a | n/a |
| P _{DC} [mW] | 363 | 117 | 74 | 85 | 90 | 333 |

Improved in-out matching - Improved linearity



[3] InP DHBT Wideband Amplifiers with up to 235 GHz Bandwidth, K. Eriksson, L. Darwazeh, H. Zirath, IMS 2014.

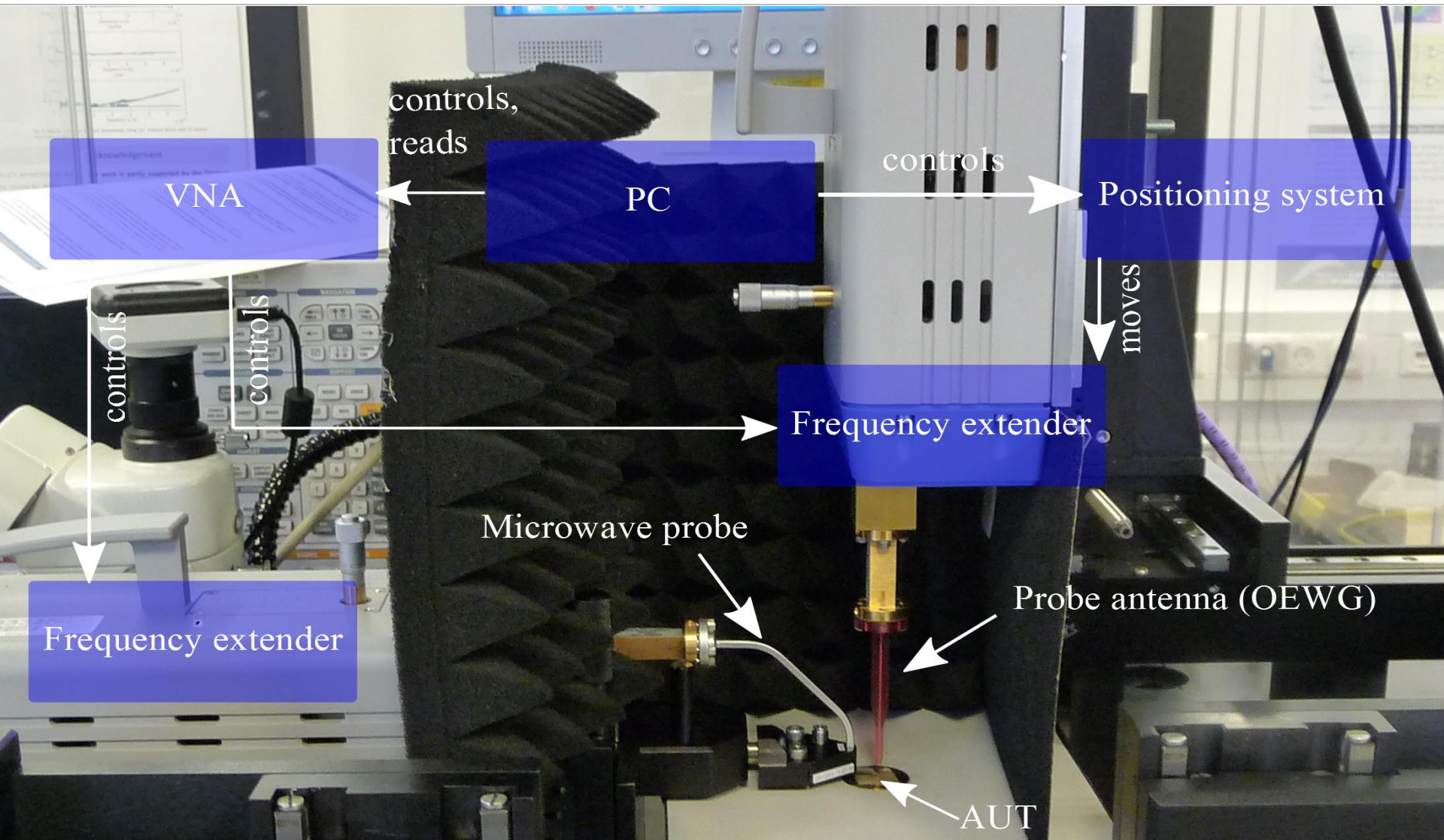


[4] 250 GHz SiGe-BiCMOS Cascaded Single Stage Distributed Amplifier, P. V. Testa, R. Paulo, C. Carta, F. Ellinger, CSICS 2015.

Analysis and Design of a 220 GHz Balanced Cascaded Single-Stage Distributed Amplifier, P.V. Testa, C. Carta, F. Ellinger, to be submitted.

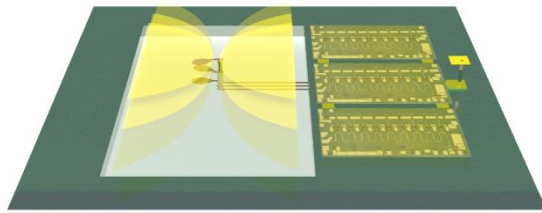
Antenna concepts

Highly Accurate Antenna Measurement Setup up to 220 GHz

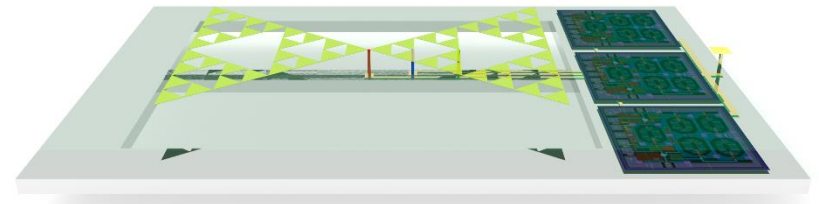


Klein, Hahnel, Seiler, Jennings, Plettmeier, "On-Chip Antenna Pattern Measurement Setup for 140 GHz to 220GHz," **IEEE ICUBB**, 2015

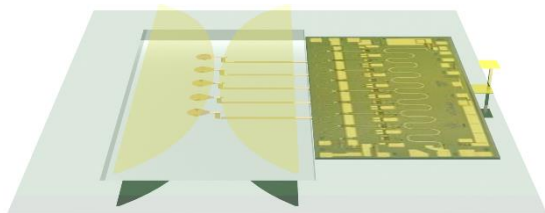
Antennas at Different Metal Levels & Locations and TWAs plus Adder



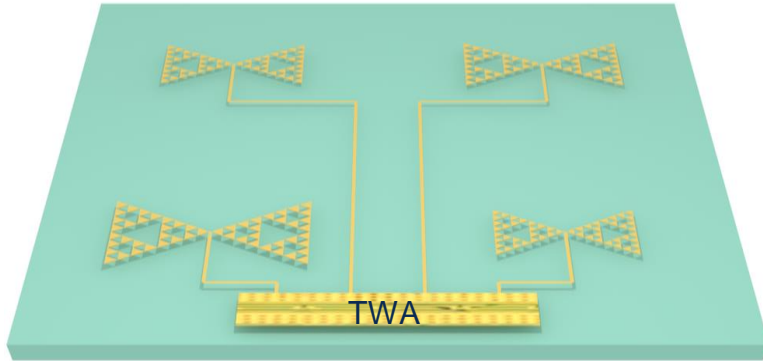
Multiple Antenna Contact Points and Frequency Scaled LNAs plus Adder



Multiple Antenna Contact Points and Distributed Adding with one TWA

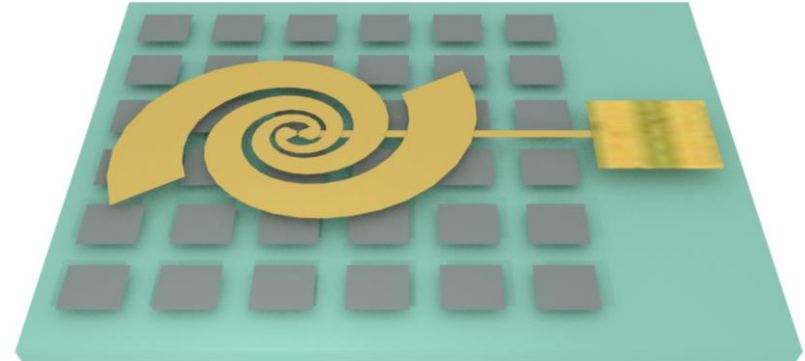


Multiple adjacent frequencies



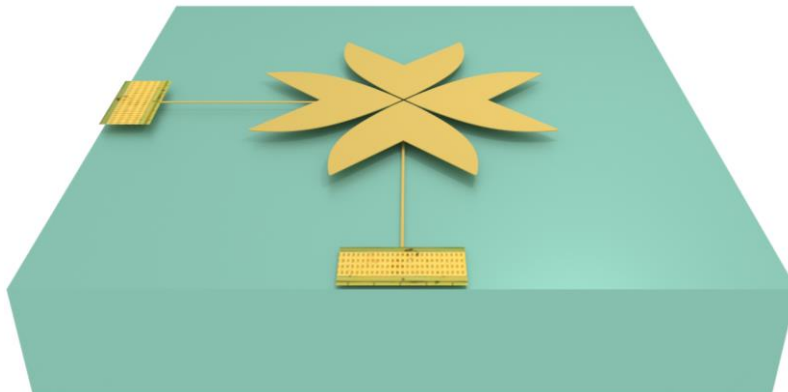
Minimize mutual coupling

Ultra-broadband



E.g. spiral antennas

Dual-polarization



BW \times 2 & less coupling

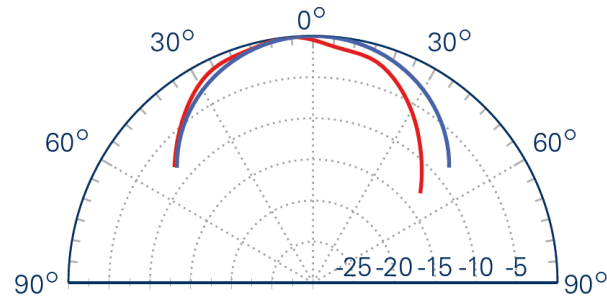
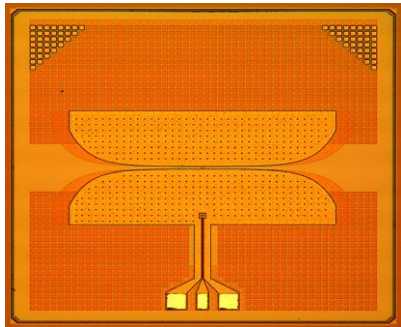
Quasi-lens



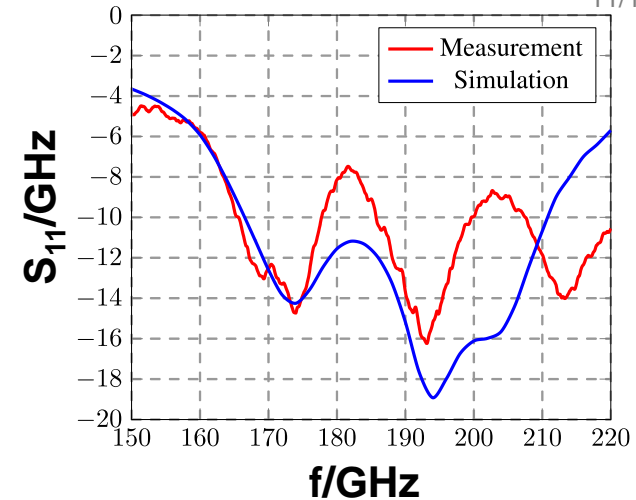
Better polarization & gain

Fully Integrated Pyramid-Stacked Slot Antennas with Vivaldi-shaped Taper

2 stacked metals

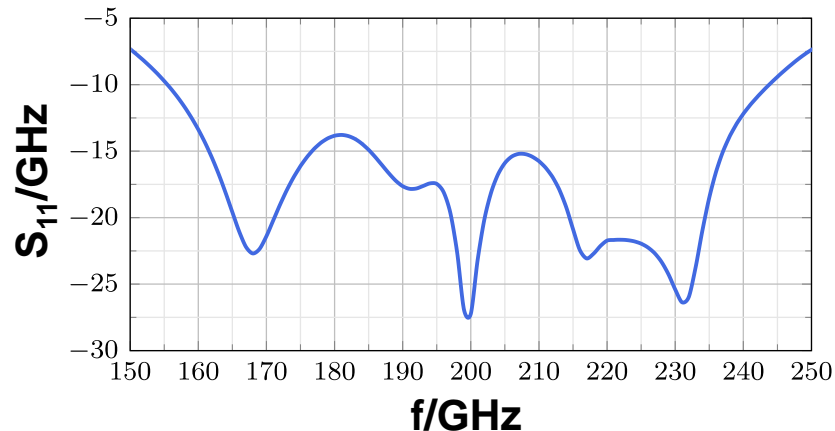


— measurement, — simulation



Hahnel, Klein, Plettemeier, Integrated stacked Vivaldi-shaped on-chip antenna for 180 GHz, **IEEE APS**, 2015

3 stacked metals, simulations



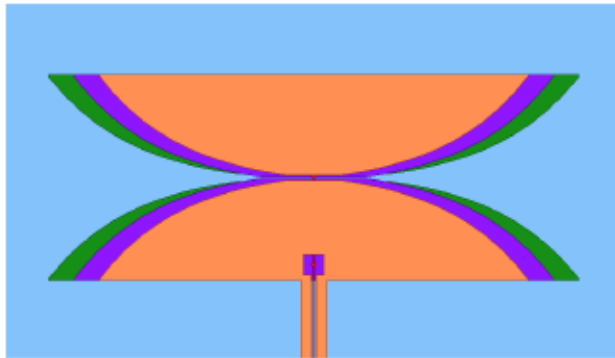
Hahnel, .. Plettemeier, .. Ellinger, Distributed On-Chip Ant. to Increase System BW at 180 GHz“, **GeMIC**, 2016

| BW | f_{center} | Gain | Ref |
|---|---------------------|--------------|-----------------------------|
| Planar & integrated in silicon | | | |
| n.a. | 140 GHz | 8 dBi | IMS14 |
| 5 GHz | 140 GHz | -2 dBi | APL11 ⁽¹⁾ |
| 45 GHz | 187 GHz | 1 dBi | DAAB |
| 89 GHz | 194 GHz | 3 dBi | DAAB^(1,2) |
| External high quality substrate | | | |
| 20 GHz | 160 GHz | 9 dBi | JSSC14 |
| 37 GHz | 230 GHz | 6 dBi | APMC14 |

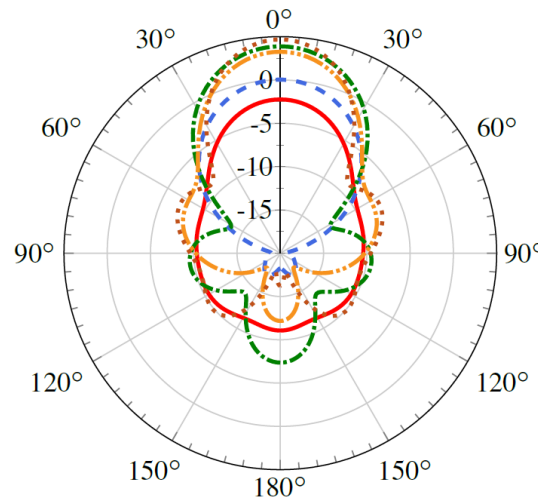
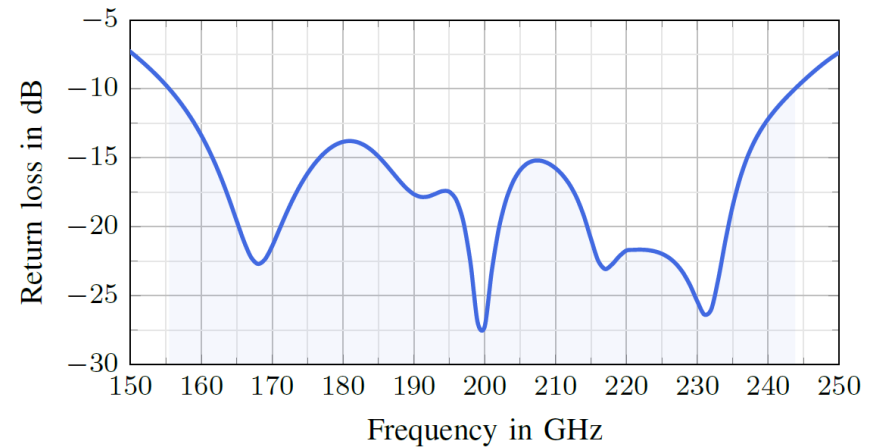
(1) Simulated (2) taped out Aug. 2015

→ **45 + 89 GHz BW Record**

Novel three stacked vivaldi-shaped open slot antenna

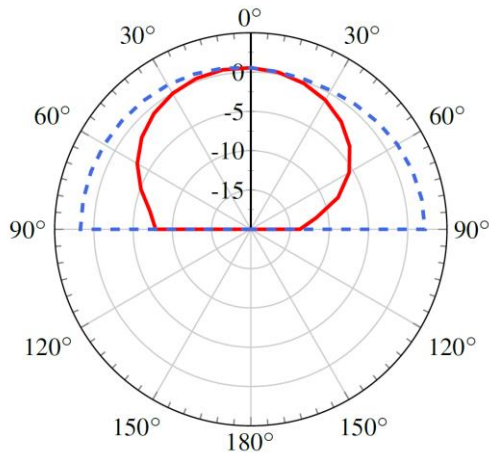
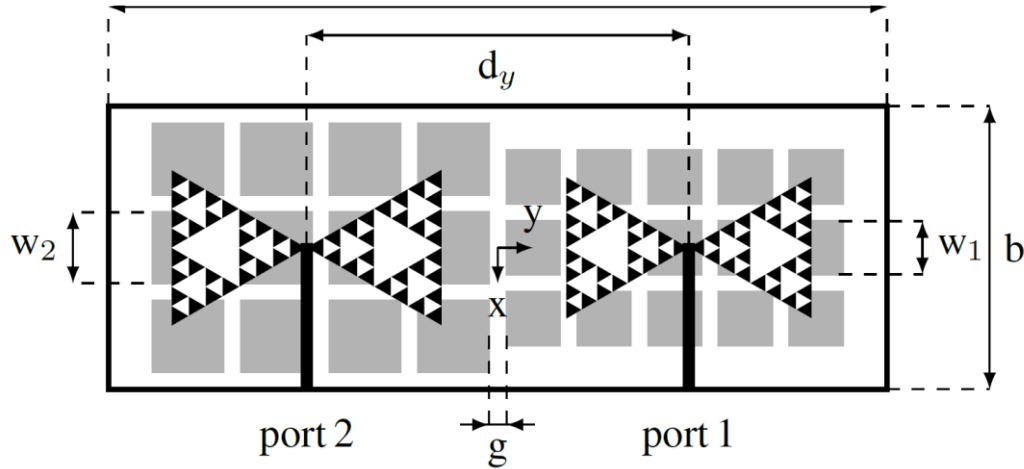


Simplified EM-Simulation model of three stacked vivaldi-shaped open slot antenna

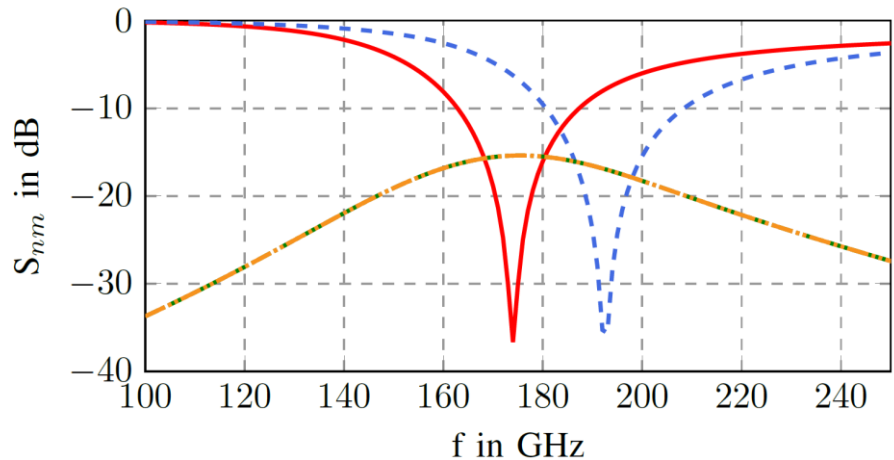


— 160 GHz, - - - 180 GHz, - · - · 200 GHz, ··· 220 GHz,
···· 240 GHz .

Multiple adjacent frequencies



Port 1 active, $f = 175$
GHz, $\phi = 0$ deg,
 $\phi = 90$ deg



— S_{11} - - S_{22} ··· S_{12} - · - S_{21}

Novel dual polarized on-chip antenna for mm-Wave applications

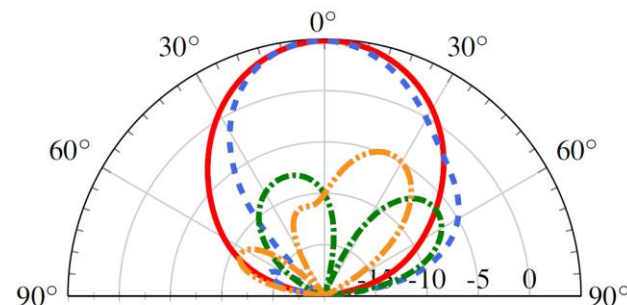
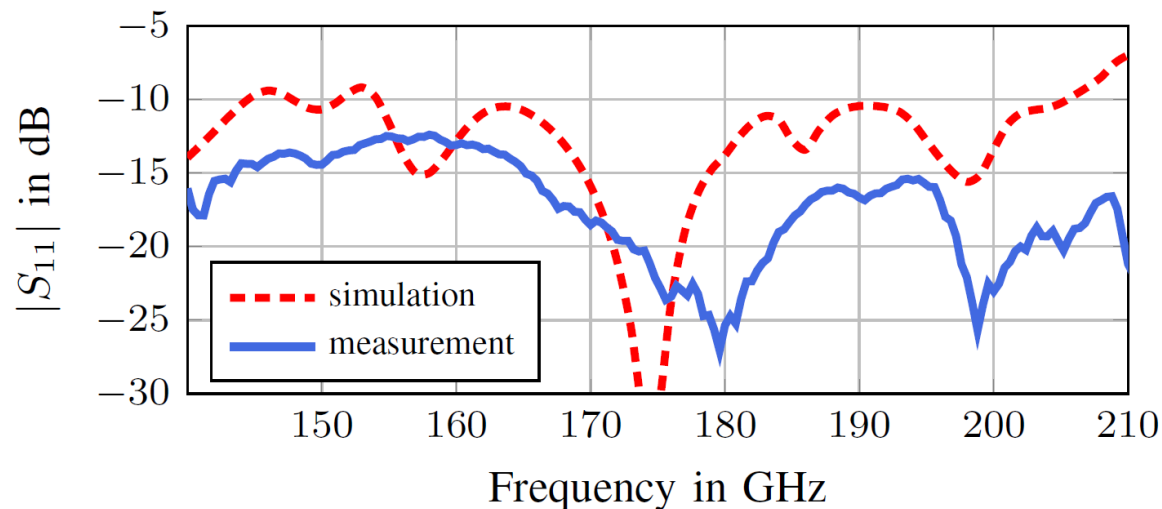
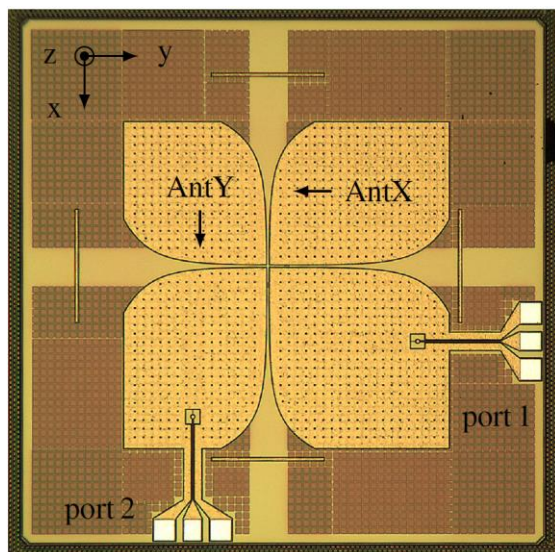
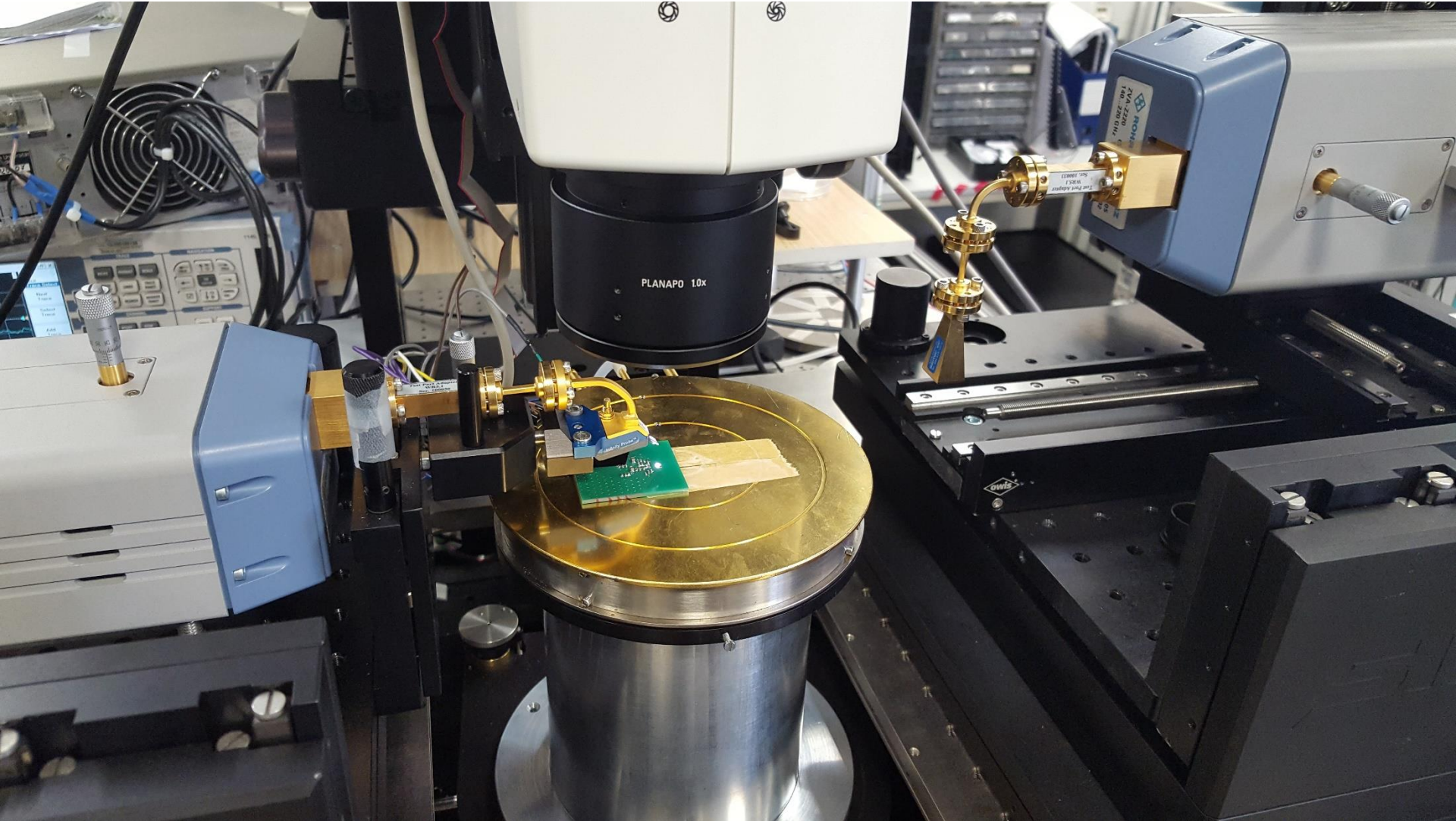


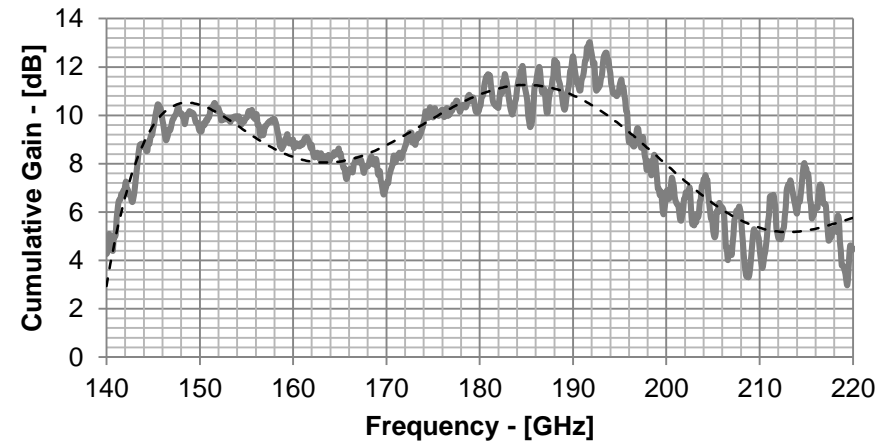
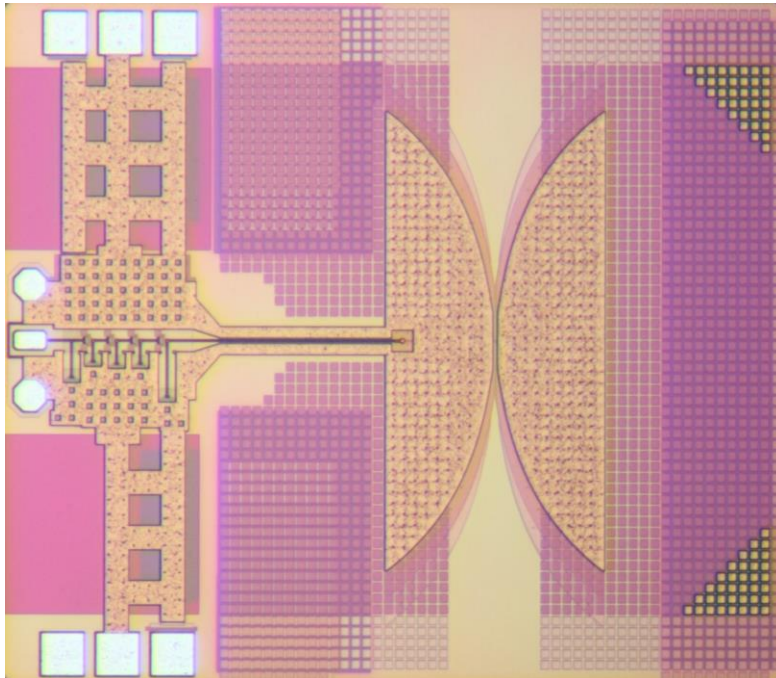
Fig. 4: Pattern in dBi at 180 GHz, port 1 with AntY excited:
realized gain, x-component: — $\varphi = 0^\circ$, - - $\varphi = 90^\circ$,
realized gain, y-component: - - $\varphi = 90^\circ$, - - $\varphi = 90^\circ$.

Integrated receiver

Measurement setup



Integrated receiver from 140 GHz to 220 GHz



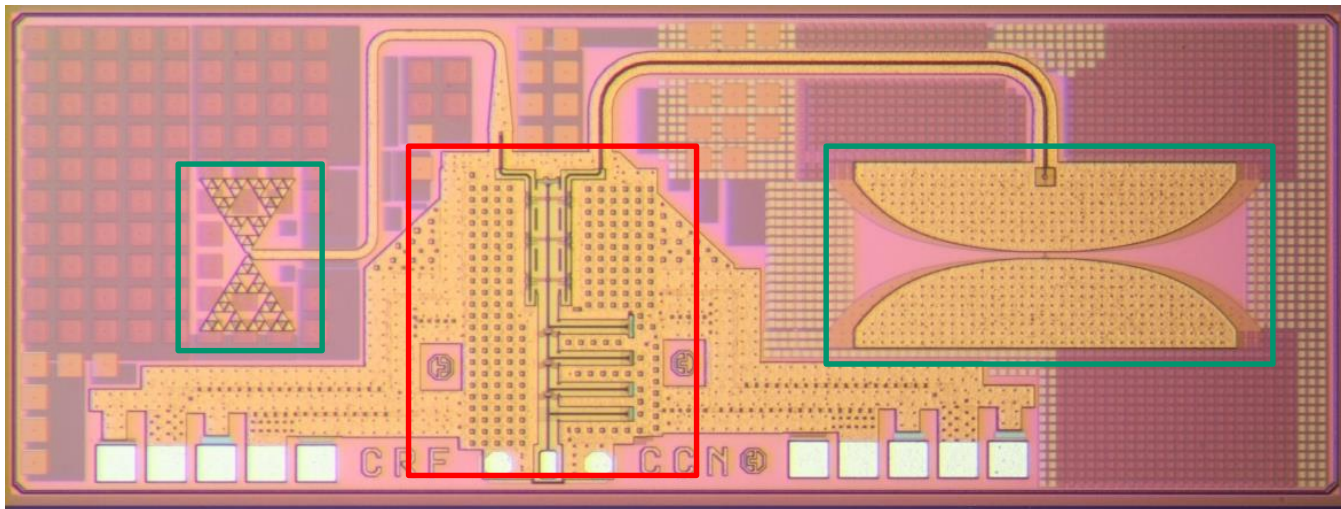
$$S_{\text{REC},21} = \sqrt{G_{\text{Ant}_R}} S_{\text{Amp}_{21}} e^{-\gamma l} \frac{1 + \frac{S_{\text{Amp}_{22}}}{S_{\text{Amp}_{21}}} - \frac{S_{\text{Amp}_{11}} S_{\text{Amp}_{22}}}{S_{\text{Amp}_{21}}^2}}{e^{2\gamma l} - \Gamma_{\text{Ant}_R} S_{\text{Amp}_{11}}}$$

P.V. Testa, B. Klein, R. Hahnel, C. Carta, D. Plettemeier, F. Ellinger, "140-220 GHz Receiver Using On-Chip Antennas and Distributed Amplifiers in SiGe BiCMOS", to be submitted to *IEEE Microwave and Wireless Components Letters*.

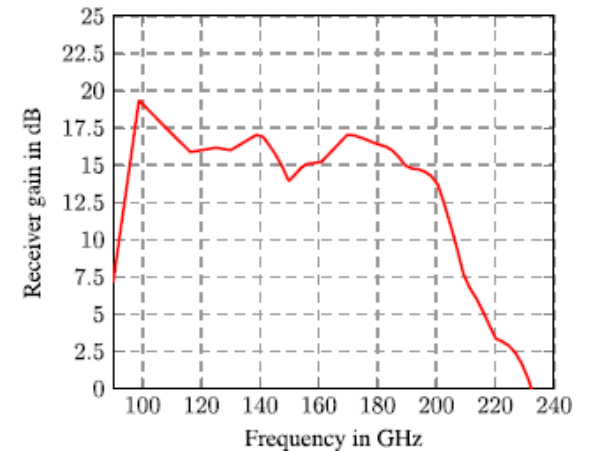
Integrated receiver from 95 GHz to 200 GHz

Fractal Bow-Tie

2-stacked vivaldi -shaped open slot antenna



Traveling wave amplifiers +
Combiner



State of the Art for Integrated Amplifier /Antennas Frontends at > 120 GHz

| Cumulative BW | Center Frequency | Amp. Gain | Antenna Gain | Tech. | Ref. |
|----------------|------------------|--------------|----------------------|-------------|-------------------------------|
| Silicon | | | | | |
| 12 GHz | 120 GHz | n.a. | 4 dBi | CMOS & wire | [Def14] |
| ~10 GHz | 170 GHz | 15 dB | -8 dBi | SiGe | [Las08] |
| ~20 GHz | 240 GHz | 5 dB | 2 dBi ⁽¹⁾ | SiGe | [Bre13] |
| 105 GHz | 148 GHz | 20 dB | 0-4 dBi | SiGe | [DAAB]^(1,2) |
| III/V | | | | | |
| 24 GHz | 220 GHz | 3.5dB | 20dBi | GaAs HEMT | [Abb15] |

(1) Simulated (2) Circuit in fabrication

→ Bandwidth improved by a factor of **5** (Si) & **4** (incl. III/V)

→ Matches well with project goal of 100 GHz BW

Dresden University of Technology
thanks you for your attention!



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